STARPOWER

SEMICONDUCTOR™

IGBT

GD400HFT120C2S

Molding Type Module

1200V/400A 2 in one-package

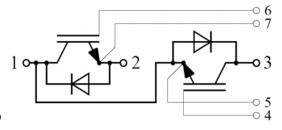
General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low V_{CE(sat)} trench IGBT technology
- Low switching losses
- 10µs short circuit capability
- V_{CE(sat)} with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

Symbol	Description	GD400HFT120C2S	Units
V _{CES}	Collector-Emitter Voltage	1200	V
V _{GES}	Gate-Emitter Voltage	±20	V
T	Collector Current @ T _C =25°C	600	Δ.
I_{C}	@ T _C =80°C	400	A
I _{CM(1)}	Pulsed Collector Current t _p =1ms	800	A
I_{F}	Diode Continuous Forward Current @ T _C =80°C	400	A
I_{FM}	Diode Maximum Forward Current t _p =1ms	800	A
P_{D}	Maximum Power Dissipation @ T _j =150°C	2119	W
T_{jmax}	Maximum Junction Temperature	150	$^{\circ}\mathbb{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\mathbb{C}$
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	2500	V
Mounting	Power Terminal Screw:M6	2.5 to 5.0	Nm
Torque	Mounting Screw:M6	3.0 to 5.0	N.m

Notes:

Electrical Characteristics of IGBT T_C =25 $^{\circ}$ C unless otherwise noted

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{(BR)CES}	Collector-Emitter	T-25°C	1200			V
	Breakdown Voltage	T _j =25℃				V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0V,$			5.0	mA
		T _j =25℃				ША
I_{GES}	Gate-Emitter Leakage	$V_{GE}=V_{GES}, V_{CE}=0V,$			400	nA
	Current	T _j =25℃			400	

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$V_{\text{GE(th)}}$	Gate-Emitter Threshold Voltage	$I_{C}=16\text{mA}, V_{CE}=V_{GE},$ $T_{j}=25^{\circ}\text{C}$	5.0	5.8	6.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I_{C} =400A, V_{GE} =15V, T_{j} =25°C		1.70	2.15	V
		I_{C} =400A, V_{GE} =15V, T_{j} =125°C		2.00	v	

⁽¹⁾ Repetitive rating: Pulse width limited by max. junction temperature

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
t _{d(on)}	Turn-On Delay Time			250		ns
t _r	Rise Time			39		ns
$t_{d(off)}$	Turn-Off Delay Time	V (00VI 400A		500		ns
$t_{\rm f}$	Fall Time	$V_{CC}=600V, I_{C}=400A,$		100		ns
Eon	Turn-On Switching	$R_G=1.8\Omega, V_{GE}=\pm 15V,$ $T_i=25^{\circ}C$		17.0		mJ
Lon	Loss	1,-23 €		17.0		1113
E_{off}	Turn-Off Switching			42.0		mJ
Loff	Loss					
$t_{d(on)}$	Turn-On Delay Time			299		ns
$t_{\rm r}$	Rise Time			46		ns
$t_{d(off)}$	Turn-Off Delay Time	V -600VI -400A		605		ns
$t_{\rm f}$	Fall Time	$V_{CC}=600V, I_{C}=400A,$ $R_{G}=1.8\Omega, V_{GE}=\pm 15V,$		155		ns
Е	Turn-On Switching	$T_{i}=125^{\circ}C$		25.1		mJ
Eon	Loss	1 _j -123 C		23.1		
E_{off}	Turn-Off Switching			61.9		mJ
Loff	Loss					
Cies	Input Capacitance	V _{CE} =25V,f=1MHz,		28.8		nF
Coes	Output Capacitance			1.51		nF
C_{res}	Reverse Transfer	$V_{GE}=0V$		1.31		nF
Cres	Capacitance			1.31		ШГ
I_{SC}		$t_{SC} \leq 10 \mu s, V_{GE} = 15 V,$				
	SC Data	$T_j=125^{\circ}C, V_{CC}=600V,$		1600		A
		$V_{CEM} \leq 1200V$				
R _{Gint}	Internal Gate Resistance			1.9		Ω
L_{CE}	Stray Inductance				20	nН
	Module Lead Resistance,	T _C =25℃		0.35		mΩ
R _{CC'+EE'}	Terminal to Chip	10-23 0				111 22

Electrical Characteristics of DIODE T_C=25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V_{F}	Diode Forward	I -400 A	T _j =25℃		1.65	2.15	V
	Voltage	$I_F = 400A$	T _j =125℃		1.65]
Qr	D 1 Cl		T _j =25℃		44		
	Recovered Charge	I _F =400A,	T _j =125℃		78		μС
I_{RM}	Peak Reverse	$V_R = 600V$,	T _j =25℃		490		
	Recovery Current	di/dt=-6000A/μs,	T _j =125℃		555		A
E _{rec}	Reverse Recovery	V _{GE} =-15V	T _j =25℃		19.0		I
	Energy		T _j =125℃		35.1		mJ

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (per IGBT)		0.059	K/W
$R_{\theta JC}$	Junction-to-Case (per DIODE)		0.106	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.035		K/W
Weight	Weight of Module	300		g

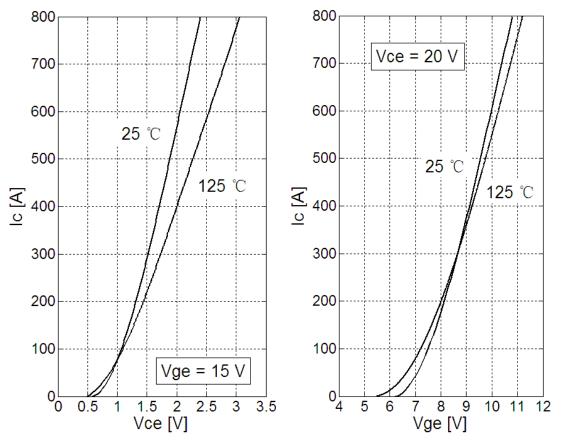


Fig 1. IGBT Typical Output Characteristics Fig 2. IGBT Typical Transfer Characteristics

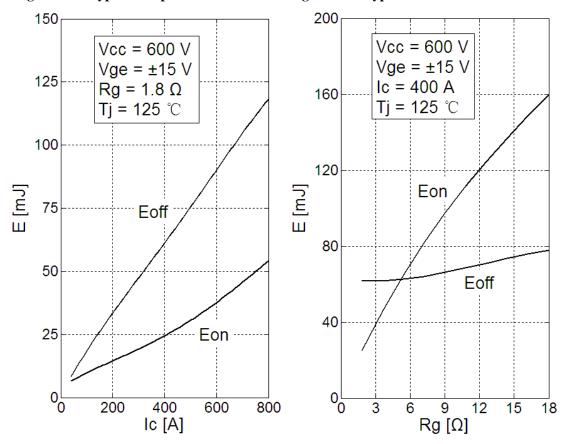


Fig 3. IGBT Switching Loss vs. I_C

Fig 4. IGBT Switching Loss vs. R_G

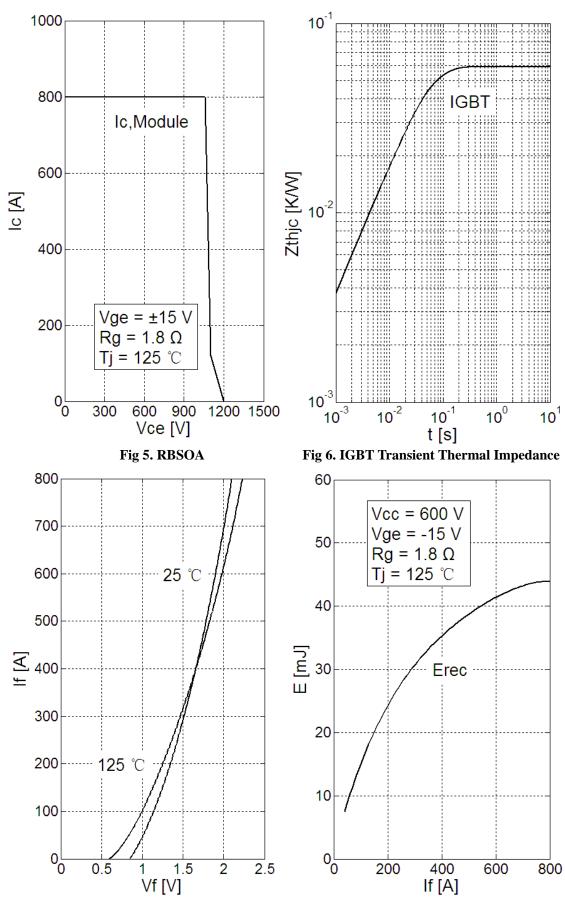


Fig 7. Diode Typical Forward Characteristics

Fig 8. Diode Switching Loss vs. $I_{\rm F}\,$

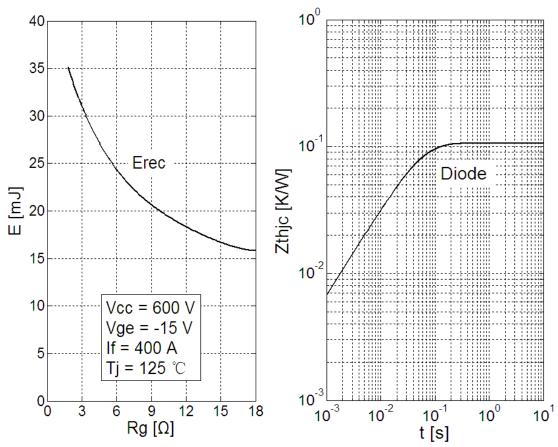
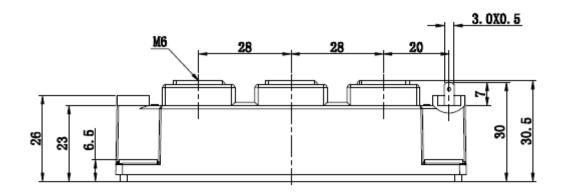


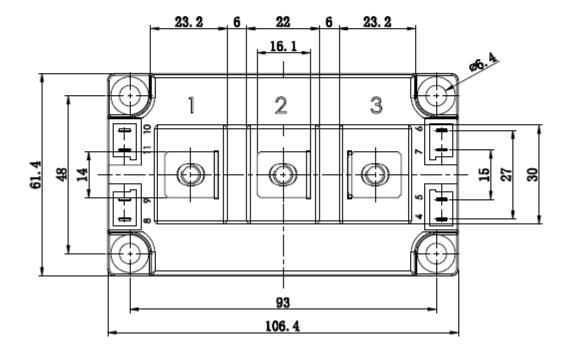
Fig 9. Diode Switching Loss vs. R_G

Fig 10. Diode Transient Thermal Impedance

Package Dimension

Dimensions in Millimeters





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